

PROBLEM 1

HEAT EQN: $\frac{\partial^2 T}{\partial x^2} + \frac{\partial^2 T}{\partial y^2} + \frac{\partial^2 T}{\partial z^2} + \frac{q}{k} = \frac{1}{\alpha} \frac{\partial T}{\partial t}$

0, NO Y, Z GRADIENTS 0, SS

$$\rightarrow \frac{\partial^2 T}{\partial x^2} + \frac{q}{k} = 0$$

BC: ① @ $x=0$ $T=T_{00}$
 ② @ $x=L$ $-k \frac{\partial T}{\partial x} = h(T(x=L) - T_{00})$

$\frac{\partial^2 T}{\partial x^2} + \frac{\gamma \sin(\frac{\pi x}{L})}{k} = 0$

INTEGRATE $\rightarrow \frac{\partial T}{\partial x} - \frac{L}{\pi} \frac{\gamma \cos(\frac{\pi x}{L})}{k} + C_1 = 0$ OR $\frac{\partial T}{\partial x} = \frac{L}{\pi} \frac{\gamma \cos(\frac{\pi x}{L})}{k} + C_1$

INTEGRATE $\rightarrow T - \left(\frac{L}{\pi}\right)^2 \frac{\gamma}{k} \sin\left(\frac{\pi x}{L}\right) + C_1 x + C_2 = 0$ OR $T = \left(\frac{L}{\pi}\right)^2 \frac{\gamma}{k} \sin\left(\frac{\pi x}{L}\right) + C_1 x + C_2$

APPLY BC ①

$$T = \frac{L^2 \gamma}{\pi^2 k} \sin(0) + C_1(0) + C_2 = T_{00} \Rightarrow C_2 = T_{00}$$

APPLY BC ②

$$-k \left[\frac{\partial T}{\partial x} = \frac{L \gamma}{\pi k} \cos\left(\frac{\pi x}{L}\right) + C_1 \right]_{x=L} = h(T(x=L) - T_{00}) = h \left[\left(\frac{L}{\pi}\right)^2 \frac{\gamma}{k} \sin\left(\frac{\pi L}{L}\right) + C_1 L + C_2 - T_{00} \right]_{x=L}$$

$$-\frac{L \gamma}{\pi} - k C_1 = -\cancel{\frac{L \gamma}{\pi}} \cos\left(\frac{\pi L}{L}\right) - k C_1 = h \left(\left(\frac{L}{\pi}\right)^2 \frac{\gamma}{k} \sin\left(\frac{\pi L}{L}\right) + C_1 L + C_2 - T_{00} \right)$$

SINCE $C_2 = T_{00}$

$$\frac{L \gamma}{\pi} - k C_1 = h C_1 L$$

$$\frac{L \gamma}{\pi} = C_1(hL + k)$$

$$C_1 = \frac{L \gamma}{\pi(hL + k)}$$

$$\Rightarrow T(x) = \left(\frac{L}{\pi}\right)^2 \frac{\gamma}{k} \sin\left(\frac{\pi x}{L}\right) + \frac{\gamma L x}{\pi(hL + k)} + T_{00}$$

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② Let's first find the parameter, $m = \sqrt{\frac{hp}{KA_c}}$, for the fin

$$p = 2\pi R;$$

$$A_c \approx 2\pi R s$$

$$m = \sqrt{\frac{hp}{KA_c}} = \sqrt{\frac{h \cdot 2\pi R}{K \cdot 2\pi R s}} = \sqrt{\frac{h}{Ks}} = \sqrt{\frac{10 \text{ [W/m}^2\text{K]}}{15 \text{ [W/mK]}}} \cdot 1 \times 10^{-3} \text{ [m]}$$

(using $s \ll R$ approximation)

$$\Rightarrow m = 25.8 \text{ } \text{m}^{-1}$$

$$\text{For this fin, } mL = 25.8 \text{ [m}^{-1}\text{]} \times 250 \times 10^{-3} \text{ [m]}$$

$$= 6.45 > 2.65$$

(infinitely long fin approx. is valid)

$$\begin{aligned} T(x=100\text{mm}) &= T_\infty + (T_b - T_\infty) e^{-mx} \\ &= 20^\circ\text{C} + (220^\circ\text{C} - 20^\circ\text{C}) e^{-25.8 \text{ [m}^{-1}\text{]} \times 0.1 \text{ [m]}} \\ &\approx 35.2^\circ\text{C} \end{aligned}$$

(b) For infinitely long fin, $q_f = \sqrt{hpKA} (T_b - T_\infty)$

$$\begin{aligned} &= \sqrt{h \cdot 2\pi R \cdot K \cdot 2\pi R s} (T_b - T_\infty) \\ &= 2\pi R \sqrt{hks} (T_b - T_\infty) \end{aligned}$$

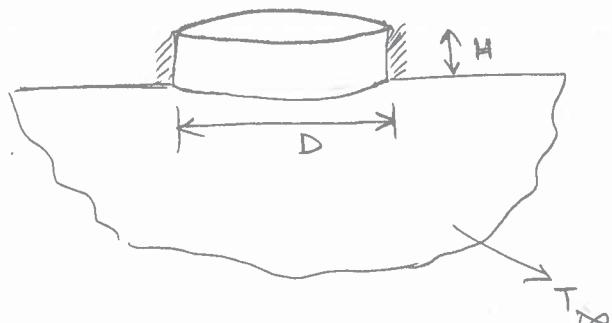
(i) Reducing L by 10%, reduces mL to $0.9 \times 6.45 = 5.8 > 2.65$.

→ The fin is still infinite. Thus reducing L does not affect q_f .

(ii) & (iii) From the formula for q_f , we can conclude that reducing R by 10% reduces q_f by 10%, while reducing s by 10% reduces q_f by $10\% / 2 = 5\%$. Option (ii) reducing R will best reduce q_f .

Note that you could also solve the same problem using the adiabatic fin tip approach and get the same answer. Since $\tanh(mL) \sim 1$ for $mL > 2.65$, q is equal for the "adiabatic fin tip" and the "infinitely long fin" approach.

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 h, T_{∞} 

$$\text{we know that } Bi = \frac{\Delta T_{\text{internal}}}{\Delta T_{\text{external}}} \\ = \frac{R_{\text{int}}}{R_{\text{ext}}}.$$

Let's first consider a characteristic internal resistance for the hot aluminum disk.

$$R_{\text{int}} = \frac{H}{k_{\text{Al}} \left(\frac{\pi D^2}{4} \right)}$$

For R_{ext} , we recognize that there are 2 resistances in parallel,

(i) convection resistance $\rightarrow R_{\text{conv}} = \frac{1}{h \left(\frac{\pi D^2}{4} \right)}$

(ii) Resistance associated with concrete floor $\rightarrow R_{\text{floor}} = \frac{1}{S' K_{\text{floor}}}$
From shape factor tables, $S' = 2D$. $R_{\text{floor}} = \frac{L}{2K_{\text{floor}} D}$

$$R_{\text{ext}} = \frac{1}{\left(\frac{1}{R_{\text{floor}}} + \frac{1}{R_{\text{conv}}} \right)} = \frac{1}{\left(\frac{2K_{\text{floor}}D}{L} + \frac{h\pi D^2}{4} \right)}$$

Condition for validity of lumped capacitance model is $Bi < 0.1$

$$\Rightarrow Bi = \frac{R_{\text{int}}}{R_{\text{ext}}} = \frac{H}{k_{\text{Al}} \left(\frac{\pi D^2}{4} \right)} \left(\frac{2K_{\text{floor}}D}{L} + \frac{h\pi D^2}{4} \right) = \boxed{\frac{\frac{8K_{\text{floor}}HD}{\pi} + h\frac{4D}{L}}{k_{\text{Al}}} < 0.1}$$

There are multiple other ways to solve this problem. One could form a resistance network for the system and use the network to find $Bi = R_{\text{int}}/R_{\text{ext}}$. Another way would be to individually compare the internal resistance to (i) the convection resistance and (ii) the conduction resistance associated with the floor ($1/2k_{\text{floor}}D$).